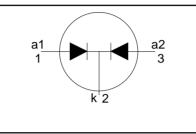
BYQ30EX series

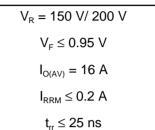
FEATURES

- Low forward volt drop
- · Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance
 Isolated mounting tab

SYMBOL



QUICK REFERENCE DATA



GENERAL DESCRIPTION

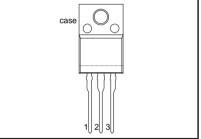
Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers in high frequency switched mode power supplies.

The BYQ30EX series is supplied in the conventional leaded SOT186A package.

PINNING

PIN	DESCRIPTION
1	anode 1
2	cathode
3	anode 2
tab	isolated

SOT186A



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	AX.	UNIT
V _{RRM} V _{RWM} V _R	Peak repetitive reverse voltage Crest working reverse voltage Continuous reverse voltage	BYQ30EX	- -	-150 150 150 150	-200 200 200 200	V V V
I _{O(AV)}	Average rectified output current (both diodes conducting) ¹	square wave $\delta = 0.5$; T _{bs} ≤ 59 °C	-	1	6	A
I _{FRM}	Repetitive peak forward current	t = 25 μs; 'δ = 0.5; T _{hs} ≤ 59 °C	-	1	6	A
I _{FSM}	Non-repetitive peak forward current per diode	t = 10 ms t = 8.3 ms sinusoidal; with reapplied $V_{RWM(max)}$ S = 0.001	-		00 10	A A
I _{RRM}	Repetitive peak reverse current per diode	$t_{p} = 2 \ \mu s; \ \delta = 0.001$	-	0	.2	A
I _{RSM}	Non-repetitive peak reverse current per diode	t _p = 100 μs	-	0	.2	A
T _{stg} T _j	Storage temperature Operating junction temperature		-40 -		50 50	Ĵ Ĵ

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
Vc	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k Ω	-	8	kV	

¹ Neglecting switching and reverse current losses.

BYQ30EX series

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. \leq 65% ; clean and dustfree	-		2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs} R _{th j-a}	heatsink	with heatsink compound without heatsink compound in free air		- - 55	5.0 7.0 -	K/W K/W K/W

ELECTRICAL CHARACTERISTICS

characteristics are per diode at $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 8 A; T _i = 150°C	-	0.83	0.95	V
		I _F = 16 Å; T _i = 150°C	-	1.0	1.15	V
		I _F = 16 A;	-	0.98	1.25	
I _R	Reverse current	$V_{R} = V_{RWM}$; T _j = 100 °C	-	0.3	0.6	mA
		$V_{R} = V_{RWM}$	-	2	30	μA
Q _s	Reverse recovery charge	$ I_{\rm F} = 2 \text{ A}; V_{\rm R} \ge 30 \text{ V}; -dI_{\rm F}/dt = 20 \text{ A}/\mu\text{s}$	-	4	11	nC
t _{rr}	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$	-	20	25	ns
		-dI _F /dt = 100 A/μs				
I Irrm	Peak reverse recovery current	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$	-	1.0	2	Α
		l-dl _c /dt = 50 A/us: T₁ = 100 °C				
V _{fr}	Forward recovery voltage	$I_F = 1 \text{ A}; \text{ d}I_F/\text{d}t = 10 \text{ A}/\mu\text{s}$	-	1	-	V

 I_{F}

I R

F

 $^{\sf V}{}_{\sf F}$

12

10

8

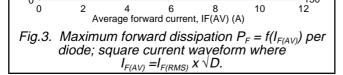
6

4

2

0

Ths(max) / C 90 dl F Forward dissipation, PF (W) 12 Vo = 0.75 V Rs 0.025 Ohms dt 10 100 a = 1.57 1.9 110 8 2.2 2.8 time 6 120 130 4 Q 100% 10% 140 2 l rrm 150 0 2 3 4 5 6 Average forward current, IF(AV) (A) 0 7 8 Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$ per diode; sinusoidal current waveform where $a = form factor = I_{F(RMS)} / I_{F(AV)}$. Fig.1. Definition of t_{rr}, Q_s and I_{rrm} trr / ns 1000 IF=10A 100 time IF=1A 10 V _{fr} V F 1 -1 10 dIF/dt (A/us) 100 time Fig.2. Definition of V_{tr} Fig.5. Maximum t_{rr} at $T_i = 25$ °C. Ths(max) / C 80 trr / ns Forward dissipation, PF (W) 1000 Vo = 0.75 V Rs = 0.025 Ohms D = 1.0 90 0.5 IF=10A 110 100 0.2 JF=1A 0.1 120 \mathbf{t}_{p} D = 130 10 140 t



100

Rev 1.200

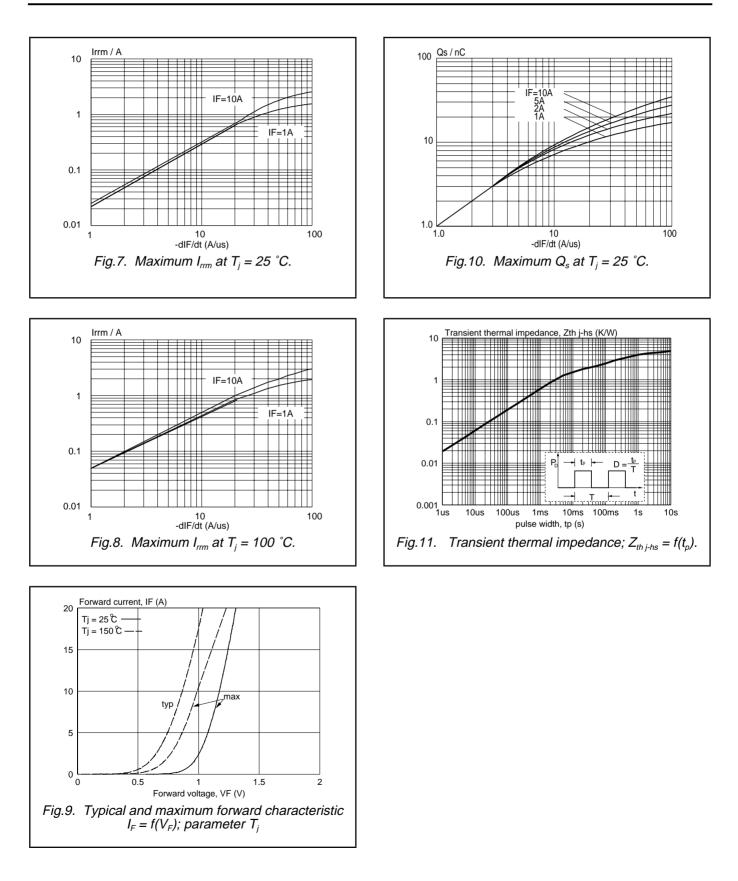
10 dIF/dt (A/us)

Fig.6. Maximum t_{rr} at $T_i = 100$ °C.

1 -1

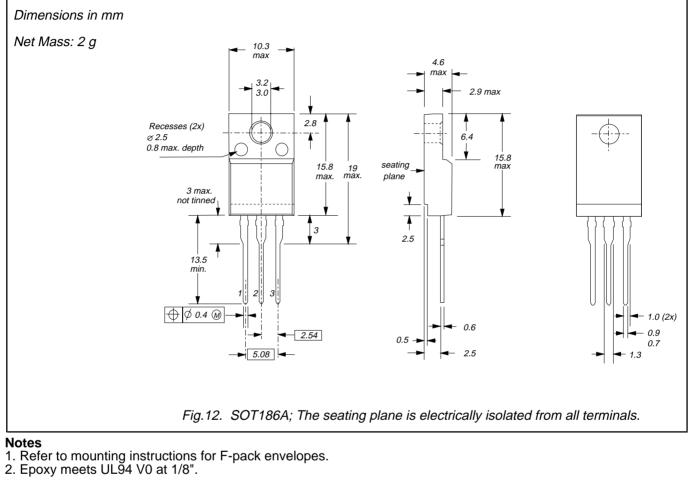
150

BYQ30EX series



BYQ30EX series

MECHANICAL DATA



BYQ30EX series

DEFINITIONS

Data sheet status				
Objective specification This data sheet contains target or goal specifications for product development.				
Preliminary specification	Preliminary specification This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				
Where application information is given, it is advisory and does not form part of the specification.				
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